

DESCRIPTION

The ICPLW50L 1MBd digital optocoupler consists of a high efficient AlGaAs Light Emitting Diode and a high speed optical detector. The output of the optical detector features an open collector Schottky clamped transistor. The internal shield ensures high common mode transient immunity.

The device is in Stretched SO6 package.

FEATURES

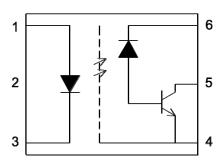
- High speed 1MBd typical
- Stretched SO6 Package
- Wide Operating Voltage Range Vcc 2.7V to 24V
- Low Drive Current 3mA
- Package Clearance / Creepage 8mm
- 15kV/µs Minimum Common Mode Rejection at V_{CM} = 1500V
- Guarantee Performance over Temperature Range: -40°C to 105°C
- TTL Compatible
- Open collector output
- Lead Free and RoHS Compliant
- UL File E91231 Model "W501"

APPLICATIONS

- Digital Signal Isolation
- Communications Interface
- Micro-controller Interface
- Digital Isolation for A/D, D/A Conversion
- Switching Power Supplies

ORDER INFORMATION

Supplied in Tape and Reel



1 Anode

2 NC

3 Cathode

4 GND

 $5 V_0$

6 V_{CC}

A 0.1μF bypass Capacitor must be connected between Pins 6 and 4.

ABSOLUTE MAXIMUM RATINGS

T_A = 25°C unless otherwise specified.

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device.

Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

Input

Forward Current	20mA
Forward Peak Current (Pulse Width = 1ms, 50% Duty Cycle)	40mA
Forward Peak Transient Current (Pulse Width = 1µs, 300pps)	1.0A
Reverse Voltage	5V
Power dissipation	36mW

Output

Output Collector Current	8mA
Peak Output Current	16mA
Supply Voltage	-0.5 to 30V
Output Collector Voltage	-0.5 to 20V
Power Dissipation	100mW

Total Package

Isolation Voltage	$5000V_{RMS}$
Operating Temperature	-40 to 105 °C
Storage Temperature	-55 to 125 °C
Lead Soldering Temperature (10s)	260°C

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Truth Table

LED	Vo
OFF	HIGH
ON	LOW

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
Operating Temperature	T_{A}	- 40	105	°C
Supply Voltage	V_{CC}	2.7	24	V
Input Current (ON)	I_{FH}	3	10	mA
Input Voltage (OFF)	$V_{\text{F(OFF)}}$		0.8	V



ELECTRICAL CHARACTERISTICS (V_{CC} = 2.7 to 24V, I_F = 3mA and T_A = -40°C to 105°C, unless otherwise specified)

INPUT

Parameter Symbol		Symbol Test Condition		Тур.	Max	Unit
Forward Voltage	V_{F}	$I_F = 3mA$	1.2	1.4	1.8	V
Reverse Voltage	V_R	$I_R = 10\mu A$	5			V

OUTPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
High Level Supply Current	I_{CCH}	$I_F = 0$ mA, $V_{CC} = 30$ V, $V_O = 0$ pen, $T_A = 25$ °C			2	μA
Low Level Supply Current	I_{CCL}	$I_F = 3\text{mA}, V_{CC} = 30\text{V}$ $V_O = \text{Open}$		60	100	μA
High Level Output Current	I_{OH}	$I_F = 0$ mA, $V_O = V_{CC} = 5.5$ V, $T_A = 25$ °C			0.5	μA
		$I_F = 0 \text{mA}, V_{CC} = 30 \text{V},$ $V_O = 20 \text{V}, T_A = 25 ^{\circ}\text{C}$			1	
		$I_F = 0mA, V_{CC} = 30V,$ $V_O = 20V$			80	
Low Level Output Voltage	V_{OL}	$I_F = 3mA$, $V_{CC} = 3.3V$ or $5V$, $I_O = 3mA$, $T_A = 25$ °C		0.25	0.4	V
		$I_F = 3\text{mA}, V_{CC} = 3.3\text{V or 5V},$ $I_O = 1.6\text{mA}, T_A = 25^{\circ}\text{C}$		0.25	0.5	

COUPLED

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Current Transfer Ratio	CTR	$I_F = 3\text{mA},$ $V_{CC} = 3.3 \text{V or } 5\text{V},$ $V_0 = 0.4 \text{V},$ $T_A = 25^{\circ}\text{C}$	90	125	200	%
		$I_F = 3\text{mA},$ $V_{CC} = 3.3\text{V or 5V},$ $V_{O} = 0.5\text{V},$	53			



ELECTRICAL CHARACTERISTICS (V_{CC} = 2.7 to 24V, I_F = 3mA and T_A = -40°C to 105°C, unless otherwise specified)

SWITCHING

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Propagation Delay Time to High Output Level	$t_{ m PLH}$	f = 10kHz, Duty Cycle = 50%, $I_F = 3mA$, $V_{CC} = 3.3V$, $R_L = 1.8K\Omega$, $C_L = 15pF$, $V_{THLH} = 2V$		0.4	1.4	μs
		$f = 10kHz, Duty Cycle = 50\%,$ $I_F = 3mA, V_{CC} = 5.0V,$ $R_L = 2.9K\Omega, C_L = 15pF,$ $V_{THLH} = 2V$		0.4	1	
Propagation Delay Time to Low Output Level	$t_{\mathtt{PHL}}$	$f = 10kHz, Duty Cycle = 50\%,$ $I_F = 3mA, V_{CC} = 3.3V,$ $R_L = 1.8K\Omega, C_L = 15pF,$ $V_{THHL} = 1.5V$		0.3	1	
		$\begin{split} f &= 10 \text{kHz}, \text{Duty Cycle} = 50\%, \\ I_F &= 3 \text{mA}, V_{\text{CC}} = 5.0 \text{V}, \\ R_L &= 2.9 \text{K}\Omega, C_L = 15 \text{pF}, \\ V_{\text{THHL}} &= 1.5 \text{V} \end{split}$		0.3	1	
Pulse Width Distortion t _{PHL} - t _{PLH} for any given device	PWD	$f = 10kHz, Duty Cycle = 50\%,$ $I_F = 3mA, V_{CC} = 3.3V,$ $R_L = 1.8K\Omega, C_L = 15pF,$ $V_{THLH} = 2V$ $V_{THHL} = 1.5V$		0.1	1.4	
		f = 10 kHz, Duty Cycle = 50%, $I_F = 3 mA$, $V_{CC} = 5.0 V$, $R_L = 2.9 K\Omega$, $C_L = 15 pF$, $V_{THLH} = 2 V$ $V_{THHL} = 1.5 V$		0.1	1	
Common Mode Transient Immunity at High Output Level	CM_H	$\begin{split} I_F &= 0 \text{mA}, \\ V_{CC} &= 3.3 \text{V or 5V}, \\ V_{CM} &= 1500 \text{V p-p} \\ R_L &= 1.8 \text{K}\Omega \text{ or } 2.9 \text{k}\Omega, \\ T_A &= 25 ^{\circ}\text{C} \end{split}$	15			kV/μs
Common Mode Transient Immunity at Low Output Level	CM_L	$I_F = 3\text{mA},$ $V_{CC} = 3.3\text{V or 5V},$ $V_{CM} = 1500\text{V p-p},$ $R_L = 1.8\text{K}\Omega \text{ or } 2.9\text{k}\Omega,$ $T_A = 25^{\circ}\text{C}$	15			kV/μs



ELECTRICAL CHARACTERISTICS ((V_{CC} = 2.7 to 24V, I_F = 3mA and T_A = -40°C to 105°C, unless otherwise specified)

ISOLATION

Parameter	Symbol Test Condition		Min	Тур.	Max	Unit
Insulation Voltage	$V_{\rm ISO}$	V_{ISO} $t = 1 \text{ min,}$ $T_A = 25^{\circ}\text{C, RH} \le 50\%,$				V
Input - Output Resistance	$R_{\text{I-O}}$	R_{I-O} $V_{I-O} = 500 VDC$		10 ¹²		Ω
Input - Output Insulation Leakage Current	$I_{\text{I-O}}$	$V_{I-O} = 3kVDC, t = 5s,$ $T_A = 25^{\circ}C, RH 45\%,$			1.0	μA

Note:

- 1. A 0.1uF bypass capacitor must be connected across pin 6 and pin 4.
- 2. CM_H , Common Mode Transient Immunity in High stage is the maximum tolerable positive dV_{CM}/dt on the leading edge of the common mode impulse signal, V_{CM} , to assure that the output will remain high ($V_O > 2.0V$).
- 3. CM_L , Common Mode Transient Immunity in Low stage is the maximum tolerable negative dV_{CM}/dt on the trailing edge of the common mode impulse signal, V_{CM} , to assure that the output will remain low ($V_O < 0.8V$).



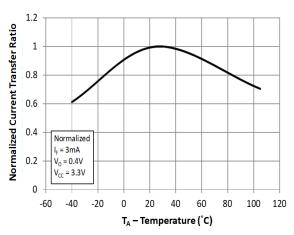


Fig 1 Normalized Current Transfer Ratio vs Ambient Temperature (Vcc=3.3V)

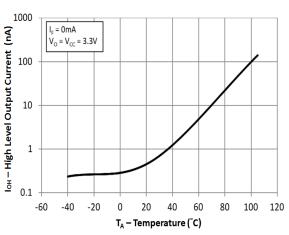


Fig 3 Typical High Level Output Curent vs Ambient Temperature (Vo=Vcc=3.3V)

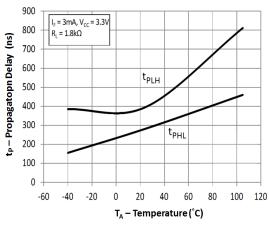


Fig 5 Typical Propagation Delay vs Ambient Temperature (Vcc=3.3V R_L =1.8k Ω)

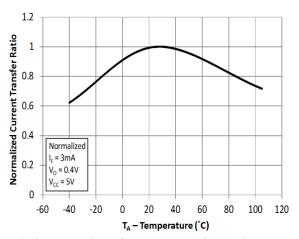


Fig 2 Normalized Current Transfer Ratio vs Ambient Temperature (Vcc=5V)

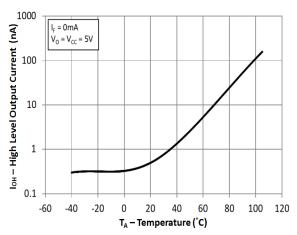


Fig 4 Typical High Level Output Current vs Ambient temperature (Vo=Vcc=5V)

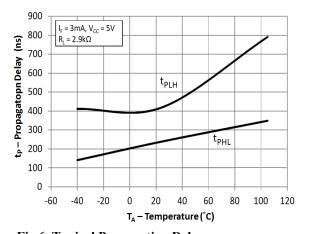


Fig 6 Typical Propagation Delay vs Ambient Temperature (Vcc=5V R_L =2.9k Ω)



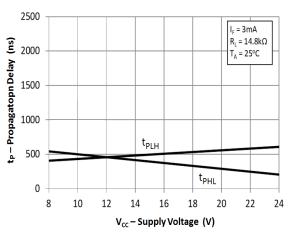


Fig 7 Typical Propagation Delay vs Supply Voltage

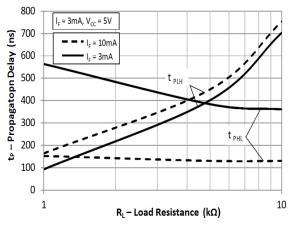


Fig 9 Typical Propagation Delay vs Load Resistance

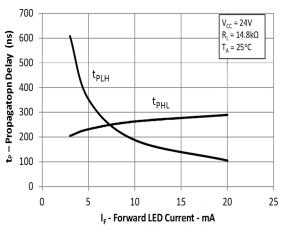


Fig 8 Typical Propagation Delay vs Forward Current

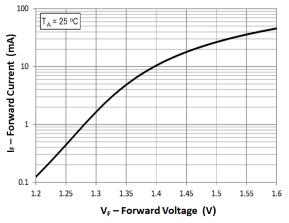
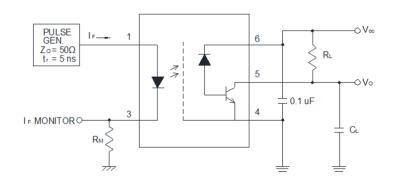
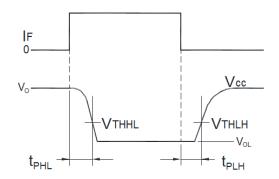


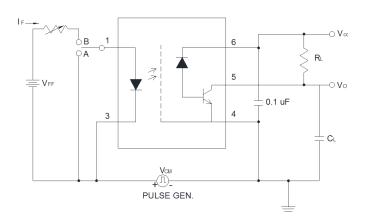
Fig 10 Forward Current vs Forward Voltage

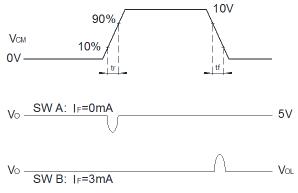






Switching Test Circuit and Waveforms





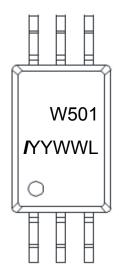
CMR Test Circuit and Waveforms



ORDER INFORMATION

ICPLW50L				
After PN PN Description Packing quantity				
None	ICPLW50L	Stretched SO6	1000 pcs per reel	

DEVICE MARKING



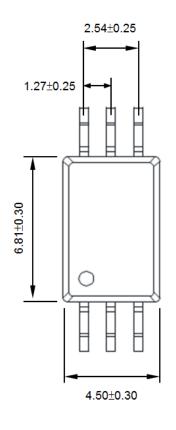
W501 denotes Device Part Number

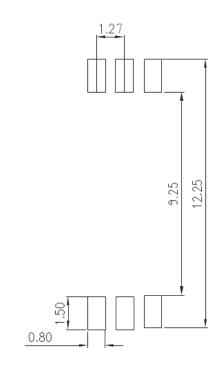
denotes Isocom

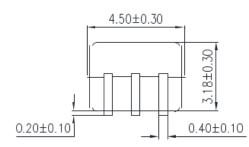
YY denotes 2 digit Year code WW denotes 2 digit Week code

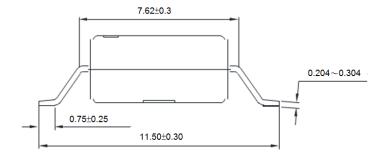


PACKAGE DIMENSIONS and Recommended PCB Pad Layout in mm (inch)



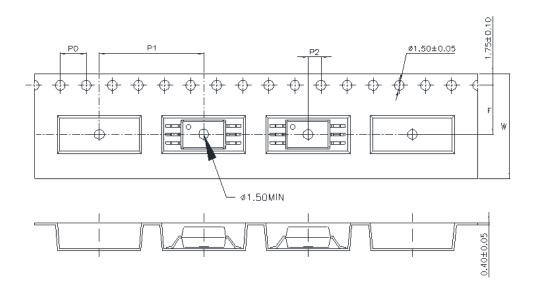








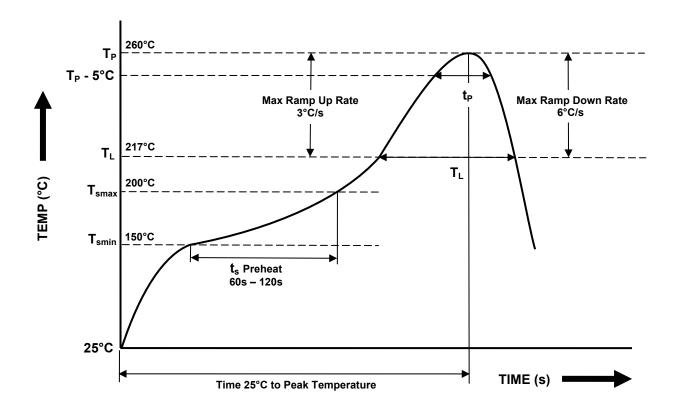
TAPE AND REEL PACKAGING



Description	Symbol	Dimension mm (inch)
Tape Width	W	16 ± 0.3 (0.63)
Pitch of Sprocket Holes	P ₀	4 ± 0.1 (0.16)
Distance of Compartment to Sprocket Holes	F	7.5 ± 0.1 (0.3)
Distance of Compartment to Sprocket Holes	P ₂	2 ± 0.1 (0.079)
Distance of Compartment to Compartment	P ₁	16 ± 0.1 (0.63)



IR REFLOW SOLDERING TEMPERATURE PROFILE One Time Reflow Soldering is Recommended. Do not immerse device body in solder paste.



Profile Details	Conditions
$ \begin{array}{l} \textbf{Preheat} \\ \textbf{- Min Temperature } (T_{SMIN}) \\ \textbf{- Max Temperature } (T_{SMAX}) \\ \textbf{- Time } T_{SMIN} \ \text{to } T_{SMAX} \ (t_s) \end{array} $	150°C 200°C 60s - 120s
$\begin{tabular}{ll} \textbf{Soldering Zone} \\ - & \begin{tabular}{ll} - & \begin{tabular}{ll} \textbf{Peak Temperature} & \begin{tabular}{ll} - & \begin{tabular}{ll} \textbf{Imperature} & \begin{tabular}{ll} \textbf{Peak Temperature} & \begin{tabular}{ll} \textbf{Imperature} & \begin{tabular}{ll} Imperature$	260°C 10s max 217°C 30s max 60s - 100s 3°C/s max 6°C/s max
Average Ramp Up Rate (T _{smax} to T _P)	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



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